

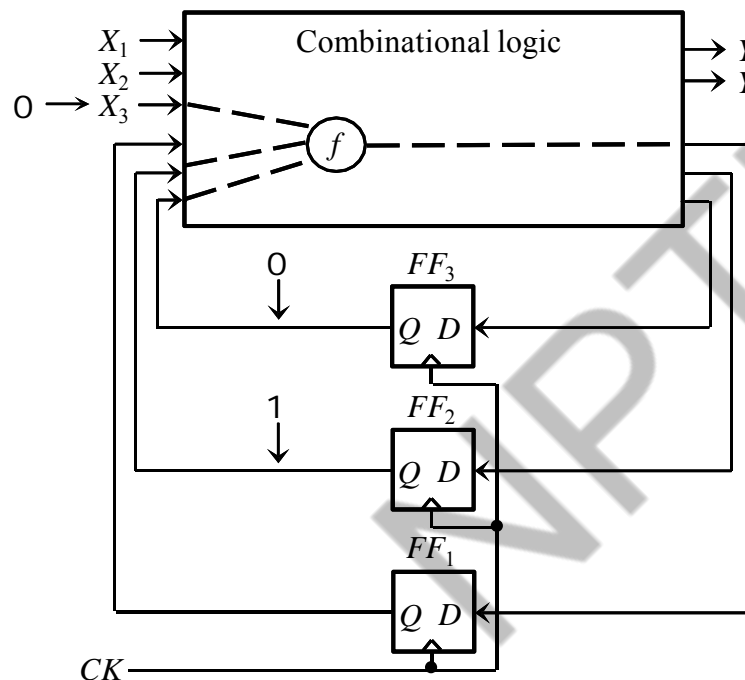
Week 2: Course Material
DFT (Contd.)
Lecture 6

Structured Approach

D Scan design

- Convert the sequential design into a scan design
- Three modes of operation
 - Normal mode
 - All test signals are turned off
 - The scan design operates in the original functional configuration
 - Shift mode
 - Capture mode
 - In both shift and capture modes, a test mode signal *TM* is often used to turn on all test-related fixes

Structured Approach - Scan Design

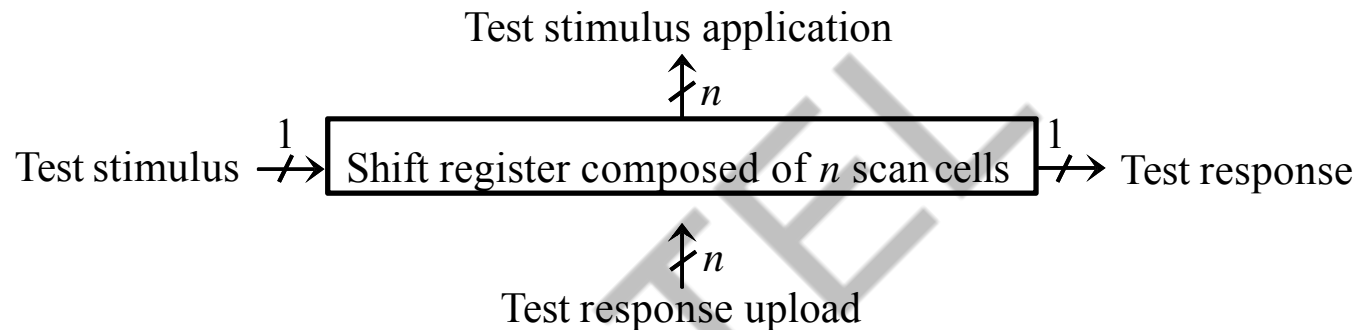


Assume that a stuck-at fault f in the combinational logic requires the primary input X_3 , flip-flop FF_2 , and flip-flop FF_3 , to be set to 0, 1, and 0.

The main difficulty in testing a sequential circuit stems from the fact that it is difficult to control and observe the internal state of the circuit.

Difficulty in testing a sequential circuit

Structured Approach - Scan Design



1. Converting
selected storage
elements in the design
into scan cells.

1. Stitching them
together to form scan
chains.

How to detect stuck-at fault f :

- (1) switching to shift mode and shifting in the desired test stimulus, 1 and 0, to FF_2 and FF_3 , respectively
- (2) driving a 0 onto primary input X_3
- (3) switching to capture mode and applying one clock pulse to capture the fault effect into FF_1
- (4) switching back to shift mode and shifting out the test response stored in FF_1 , FF_2 , and FF_3 for comparison with the expected response.

Scan Cell Design

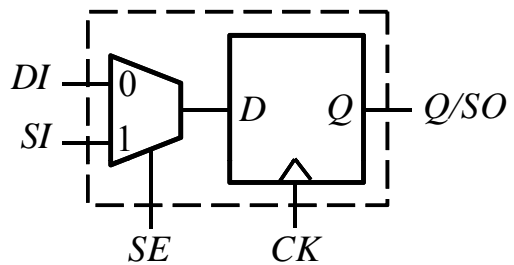
▷ A scan cell has two inputs: data input and scan input

- In normal/capture mode, data input is selected to update the output
- In shift mode, scan input is selected to update the output

▷ Three widely used scan cell designs

- Muxed-D Scan Cell
- Clocked-Scan Cell
- LSSD Scan Cell

Muxed-D Scan Cell

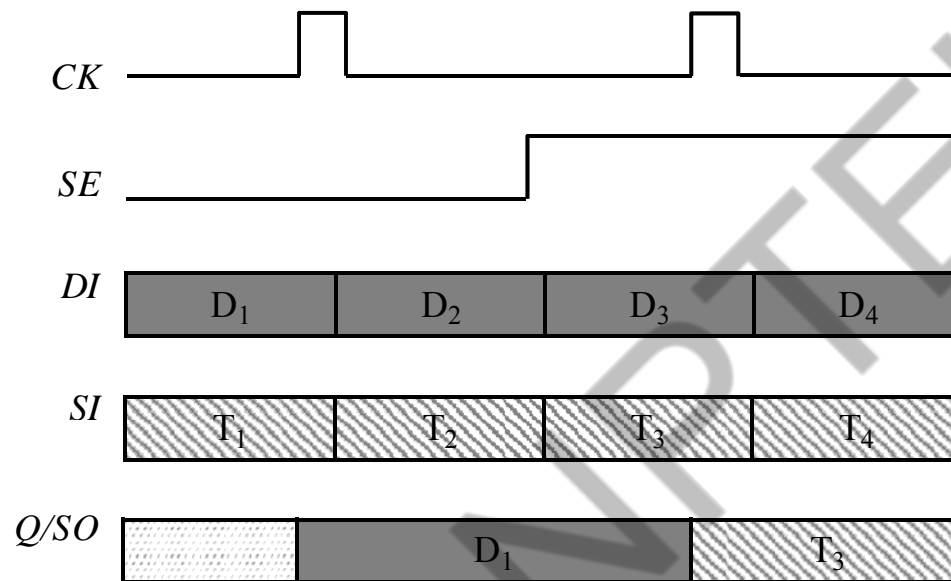


Edge-triggered
muxed-D scan
cell

This scan cell is composed of a **D flip-flop** and a **multiplexer**.

The multiplexer uses an additional scan enable input ***SE*** to select between the data input ***DI*** and the scan input ***SI***.

Muxed-D Scan Cell

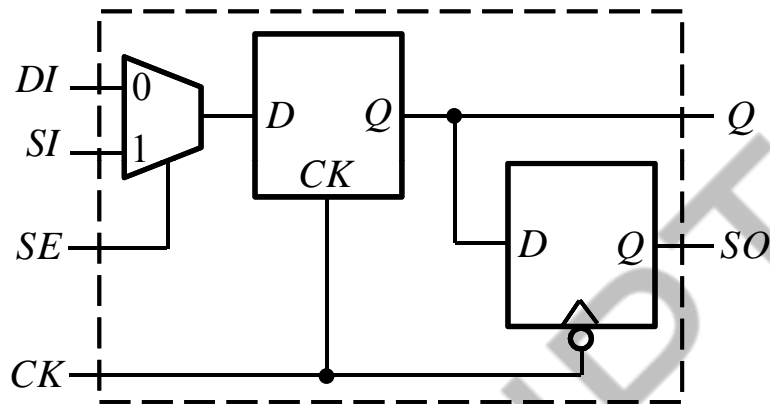


Edge-triggered muxed-D scan cell design and operation

In normal/capture mode, SE is set to 0. The value present at the data input DI is captured into the internal D flip-flop when a rising clock edge is applied.

In shift mode, SE is set to 1. The scan input SI is used to shift in new data to the D flip-flop, while the content of the D flip-flop is being shifted out.

Muxed-D Scan Cell

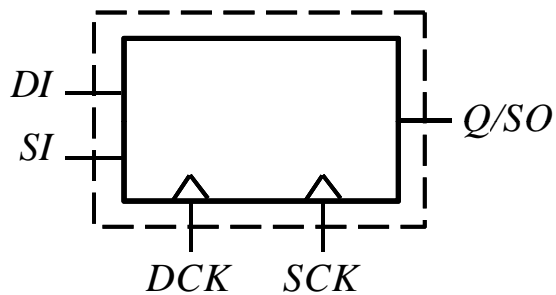


Level-sensitive/edge-triggered muxed-D scan cell design

This scan cell is composed of a multiplexer, a **D latch**, and a D flip-flop.

In this case, shift operation is conducted in an **edge-triggered** manner, while normal operation and capture operation is conducted in a **level-sensitive** manner.

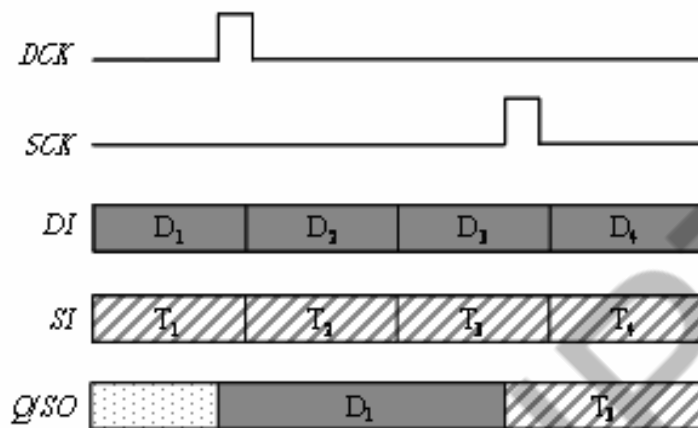
Clocked-Scan Cell



In the clocked-scan cell, input selection is conducted using two independent clocks, *DCK* and *SCK*.

Clocked-scan cell

Clocked-Scan Cell

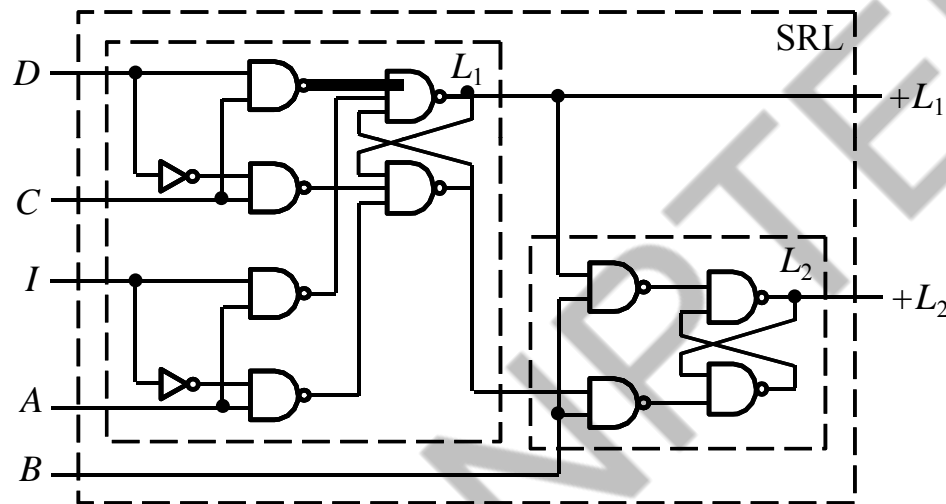


Clocked-scan cell design
and operation

In normal/capture mode, the data clock *DCK* is used to capture the contents present at the data input *DI* into the clocked-scan cell.

In shift mode, the shift clock *SCK* is used to shift in new data from the scan input *SI* into the clocked-scan cell, while the content of the clocked-scan cell is being shifted out.

LSSD Scan Cell

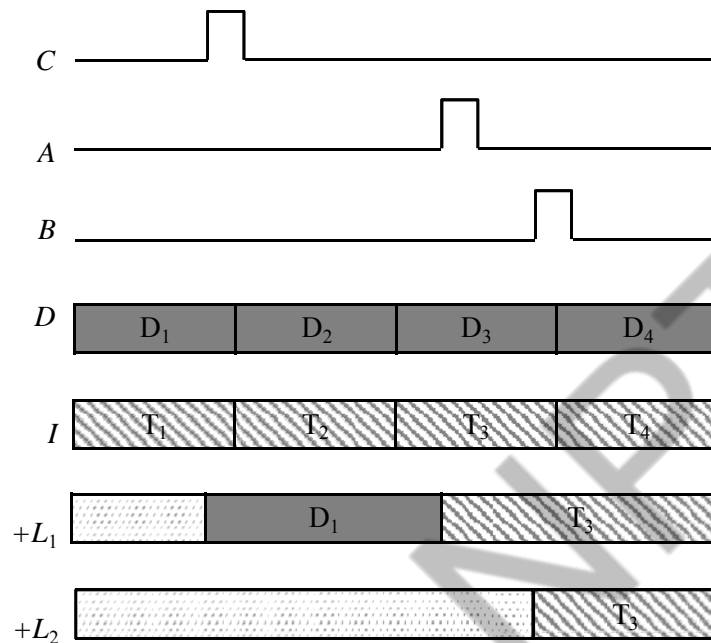


Polarity-hold SRL
(shift register latch)

An LSSD scan cell is used for level-sensitive latch base designs.

This scan cell contains two latches, a master 2-port D latch L_1 and a slave D latch L_2 . Clocks C , A and B are used to select between the data input D and the scan input I to drive $+L_1$ and $+L_2$. In an LSSD design, either $+L_1$ or $+L_2$ can be used to drive the combinational logic of the design.

LSSD Scan Cell



In order to guarantee race-free operation, clocks A , B , and C are applied in a non-overlapping manner.

The master latch L_1 uses the system clock C to latch system data from the data input D and to output this data onto $+L_1$. Clock B is used after clock A to latch the system data from latch L_1 and to output this data onto $+L_2$.

Polarity-hold SRL design and operation

Comparing three scan cell designs

Advantages		Disadvantages
Muxed-D Scan modern Cell	<p>Compatibility to designs</p> <p>Comprehensive support provided by existing design automation tools</p>	Add a multiplexer delay
Clocked-Scan degradation Cell	No performance	Require additional shift clock routing
LSSD Scan based Cell	<p>Insert scan into a latch-design</p> <p>Guarantee to be race-free</p>	Increase routing complexity

DFT (Contd.)

Lecture 7

Scan Architectures

▮ Full-Scan Design

- All or almost all storage element are converted into scan cells and combinational ATPG is used for test generation

▮ Partial-Scan Design

- A subset of storage elements are converted into scan cells and sequential ATPG is typically used for test generation

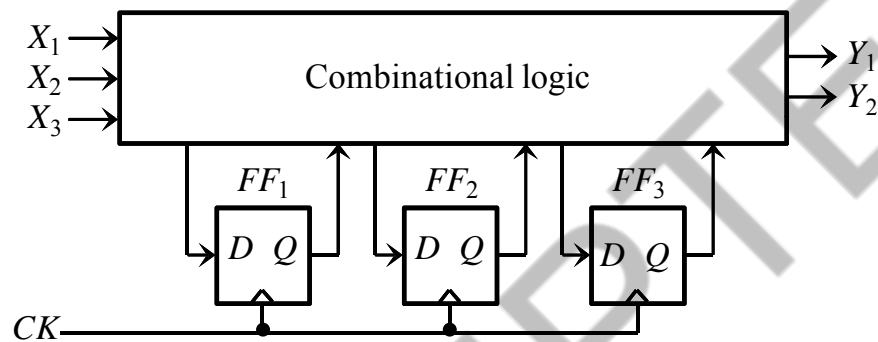
▮ Random-Access Scan Design

- A random addressing mechanism, instead of serial scan chains, is used to provide direct access to read or write any scan cell

Full-Scan Design

- ▮ All storage elements are replaced with scan cells
 - All inputs can be controlled
 - All outputs can be observed
- ▮ Advantage:
 - Converts sequential ATPG into combinational ATPG
- ▮ Almost full-scan design
 - A small percentage of storage elements are not replaced with scan cells
 - For performance reasons
 - Storage elements that lie on critical paths
 - For functional reasons
 - Storage elements driven by a small clock domain that are deemed too insignificant to be worth the additional scan insertion effort

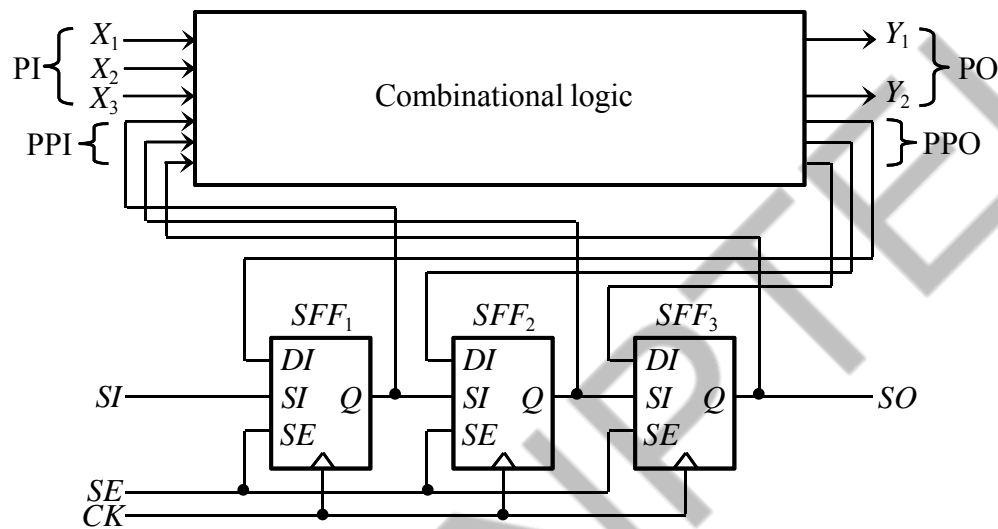
Muxed-D *Full-Scan* *Design*



Sequential circuit example

The three D flip-flops, FF_1 , FF_2 and FF_3 , are replaced with three muxed-D scan cells, SFF_1 , SFF_2 and SFF_3 , respectively.

Muxed-D *Full-Scan* *Design*



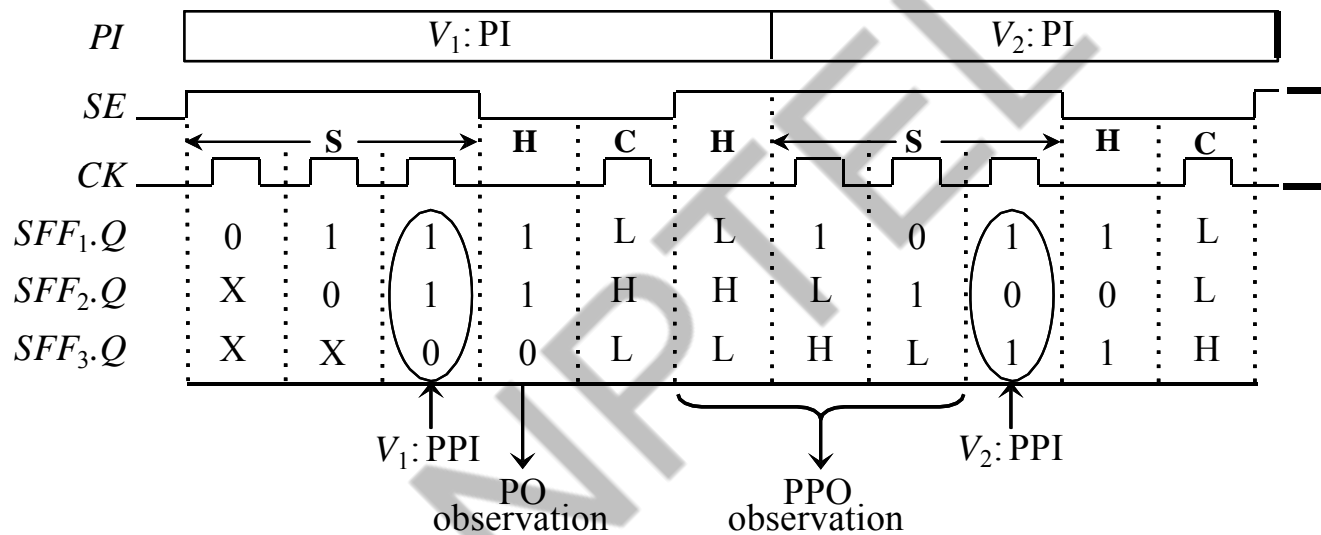
(a) Muxed-D full-scan circuit

To form a **scan chain**, the scan input SI of SFF_2 and SFF_3 are connected to the output Q of the previous scan cell, SFF_1 and SFF_2 , respectively. In addition, the scan input SI of the first scan cell SFF_1 is connected to the primary input SI , and the output Q of the last scan cell SFF_3 is connected to the primary output SO .

Muxed-D *Full-Scan* *Design*

- *Primary inputs (PIs)*
 - the external inputs to the circuit
 - can be set to any required logic values
 - set directly in parallel from the external inputs
- *Pseudo primary inputs (PPIs)*
 - the scan cell outputs
 - can be set to any required logic values
 - are set serially through scan chain inputs
- *Primary outputs (POs)*
 - the external outputs of the circuit
 - can be observed
 - are observed directly in parallel from the external outputs
- *Pseudo primary outputs (PPOs)*
 - the scan cell inputs
 - can be observed
 - are observed serially through scan chain outputs

Muxed-D *Full-Scan* *Design*



S: shift operation / **C:** capture operation / **H:** hold cycle

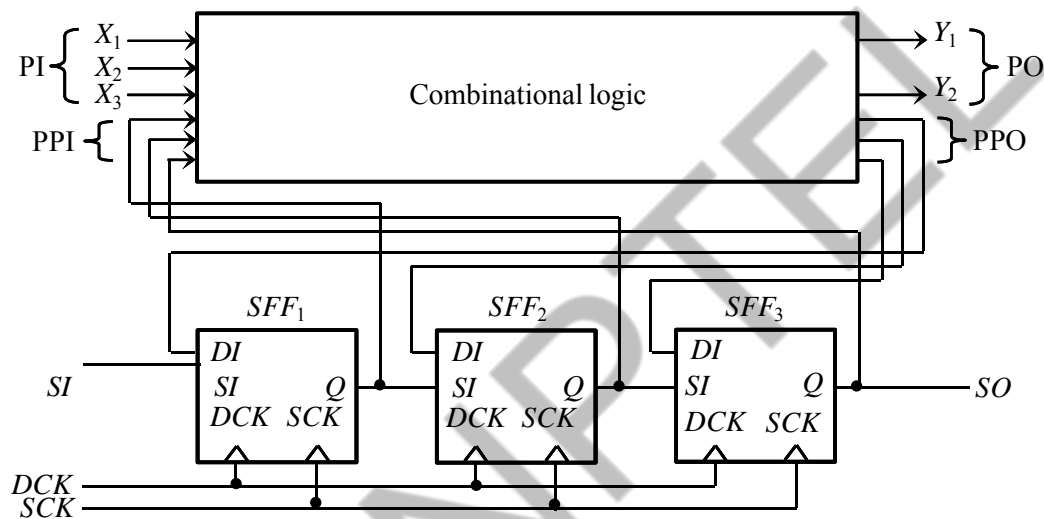
(b) Test operations

Muxed-D *Full-Scan* *Design*

Circuit Operatio n type	Sca n cell mod e	<i>TM</i>	SE
Normal	Normal	0	0
Shift Operation	Shift	1	1
Capture Operation	Capture	1	0

Circuit operation type and scan cell
mode

Clocked *Full-Scan* *Design*



Clocked full-scan circuit

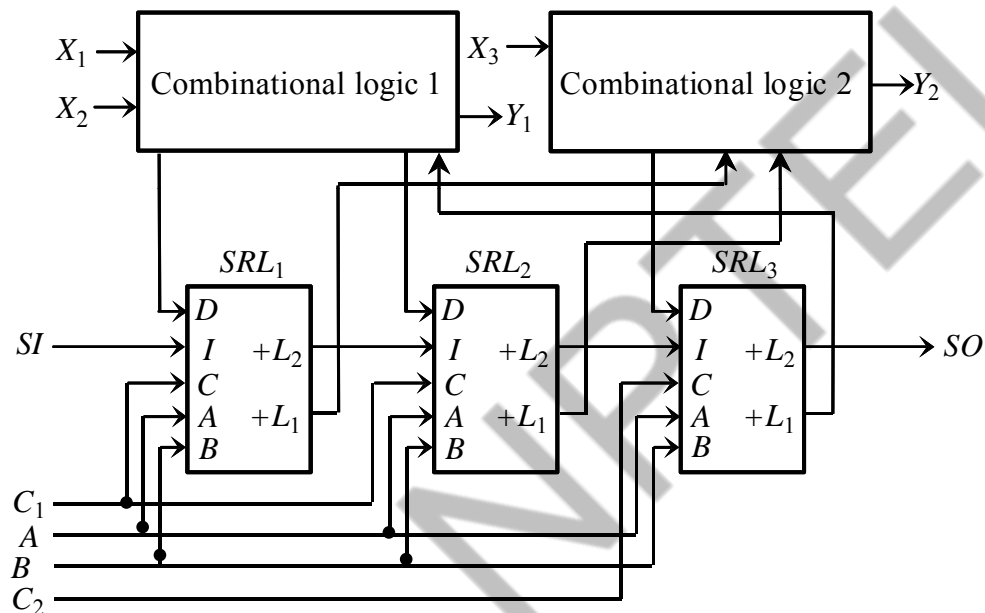
In a muxed-D full-scan circuit, a scan enable signal *SE* is used.

In a clocked full-scan design, two operations are distinguished by properly applying the two independent clocks *SCK* and *DCK* during shift mode and capture mode.

LSSD *Full-Scan Design*

- ▯ Single-latch design
- ▯ Double-latch design

LSSD *Full-Scan Design*



Single-latch design

The output port $+L_1$ of the master latch L_1 is used to drive the combinational logic of the design. In this case, the slave latch L_2 is only used for scan testing.

During the **capture** operation, clocks C_1 and C_2 are applied to load the test response from the combinational logic into the scan cells.

LSSD Design Rules

- ▯ All storage elements must be polarity-hold latches.
- ▯ The latches are controlled by two or more non- overlapping clocks.
- ▯ A set of clock primary inputs must follow three conditions:
 - All clock inputs to SRLs must be inactive when clock PIs are inactive
 - The clock input to any SRL must be controlled from one or more clock primary inputs
 - No clock can be ANDed with another clock or its complement


LSSD Design Rules

- ▷ Clock primary inputs must not feed the data inputs to SRLs either directly or through combinational logic.
- ▷ Each system latch must be part of an SRL, and each SRL must be part of a scan chain.
- ▷ A scan state exists under certain conditions:
 - Each SRL or scan out SO is a function of only the preceding SRL or scan input SI in its scan chain during the scan operation
 - All clocks except the shift clocks are disabled at the SRL clock inputs

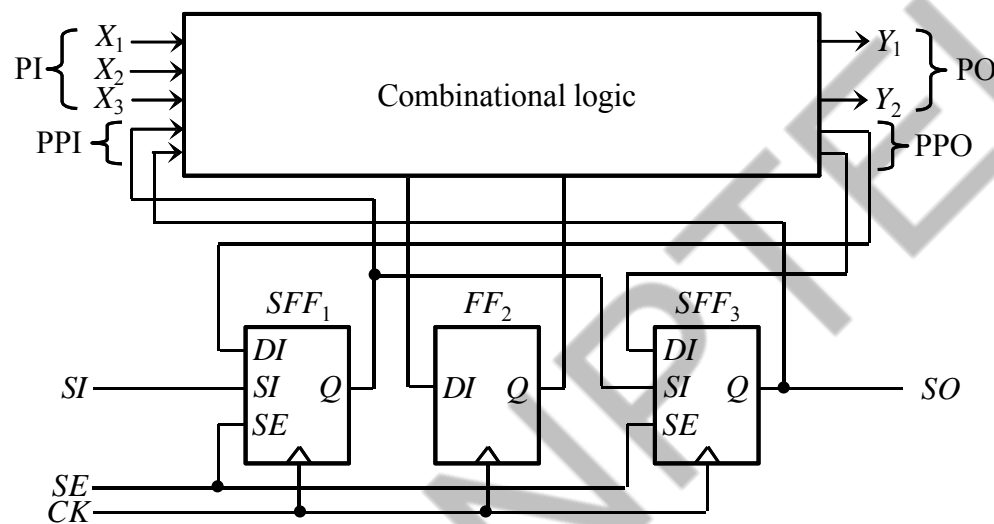
DFT (Contd.)

Lecture 8

Partial-Scan Design

- ▮ Was once used in the industry long before full-scan design became the dominant scan architecture.
 - ▮ Can also be implemented using muxed-D scan cells, clocked-scan cells, or LSSD scan cells.
 - ▮ Either combinational ATPG or sequential ATPG can be used.
- 

Partial-Scan Design



An example of muxed-D partial-scan design

A scan chain is constructed with two scan cells SFF_1 and SFF_3 , while flip-flop FF_2 is left out.

It is possible to reduce the test generation complexity by splitting the single clock into two separate clocks, one for controlling all scan cells, the other for controlling all non-scan storage elements.

However, this may result in additional complexity of routing two separate clock trees during physical implementation.

Partial-Scan Design

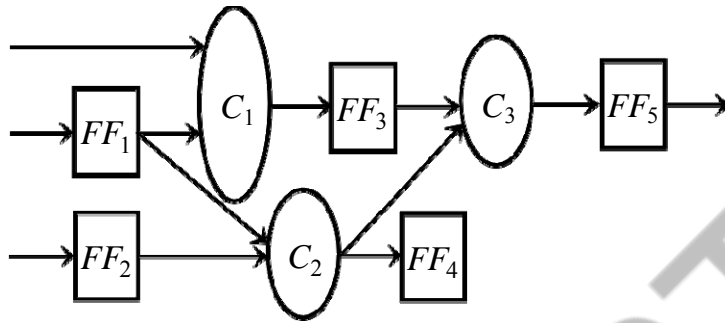
D Scan cell selection

- A functional partitioning approach
 - A circuit is composed of a data path portion and a control portion
 - Storage elements on the data path are left out of the scan cell replacement process
 - Storage elements on the control path can be replaced with scan cells
- A pipelined or feed-forward partial-scan design approach
 - Make the sequential circuit feedback-free by selecting the storage elements to break all sequential feedback loops
 - First construct a **structure graph** for the sequential circuit
- A balanced partial-scan design approach
 - Use a target sequential depth to simplify the test generation process for the pipelined or feed-forward partial-scan design

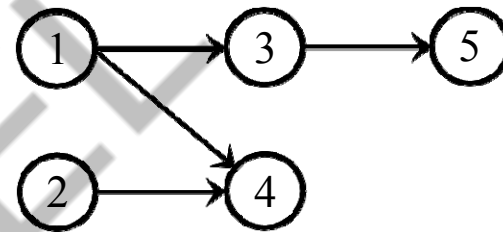
Partial-Scan Design - Structure Graph

- ▷ A feedback-free sequential circuit
 - Use a *directed acyclic graph* (DAG)
 - The maximum level in the structure graph is referred to as **sequential depth**
- ▷ A sequential circuit containing feedback loops
 - Use a *directed cyclic graph* (DCG)

Sequential circuit and its structure graph



(a) Sequential Circuit



(b) Structure graph
Sequential depth is 3

The sequential depth of a circuit is equal to **the maximum number of clock cycles** that needs to be applied in order to control and observe values to and from all non-scan storage elements

- The sequential depth of a full-scan circuit is **0**

Partial-Scan Design

▮ Advantage:

- Reduce silicon area overhead
- Reduce performance degradation

▮ Disadvantage:

- Can result in lower fault coverage
- Longer test generation time
- Offers less support for debug, diagnosis and failure analysis

Random-Access Scan Design

D Advantages of RAS:

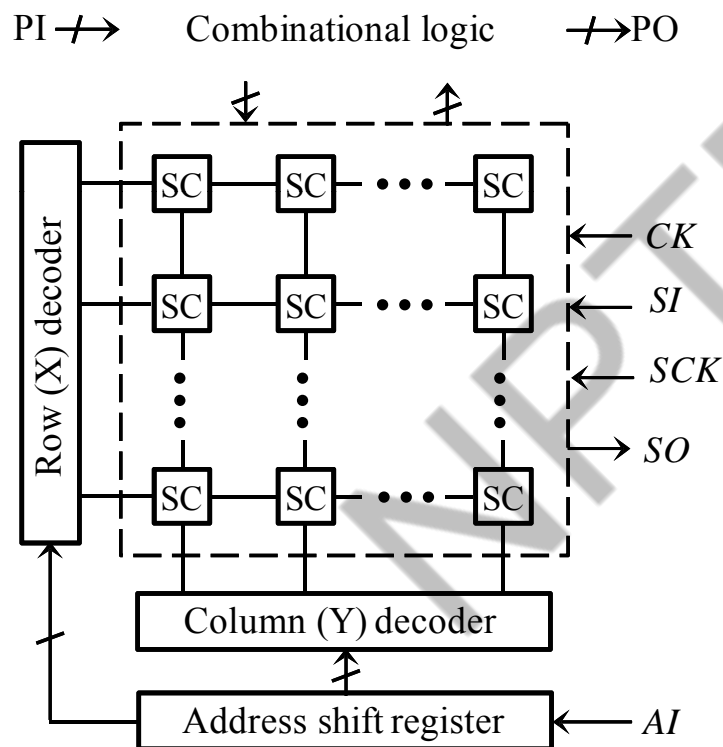
- Can control or observe individual scan cells without affecting others
- Reduce test power dissipation
- Simplify the process of performing delay test

D Disadvantages of traditional RAS:

- High overhead in scan design and routing
- No guarantee to reduce the test application time

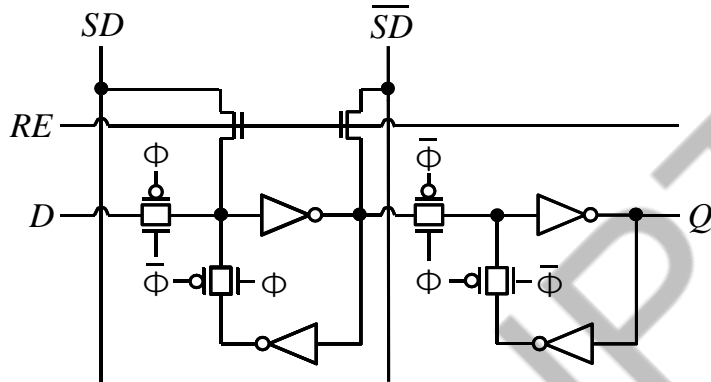
D Progressive Random-Access Scan(PRAS) was proposed to alleviate the disadvantages in traditional RAS

Traditional random-access scan architecture



All scan cells are organized into a two-dimensional array. A $\lceil \log_2 n \rceil$ -bit address shift register, where n is the total number of scan cells, is used to specify which scan cell to access.

Progressive Random-Access Scan (PRAS)



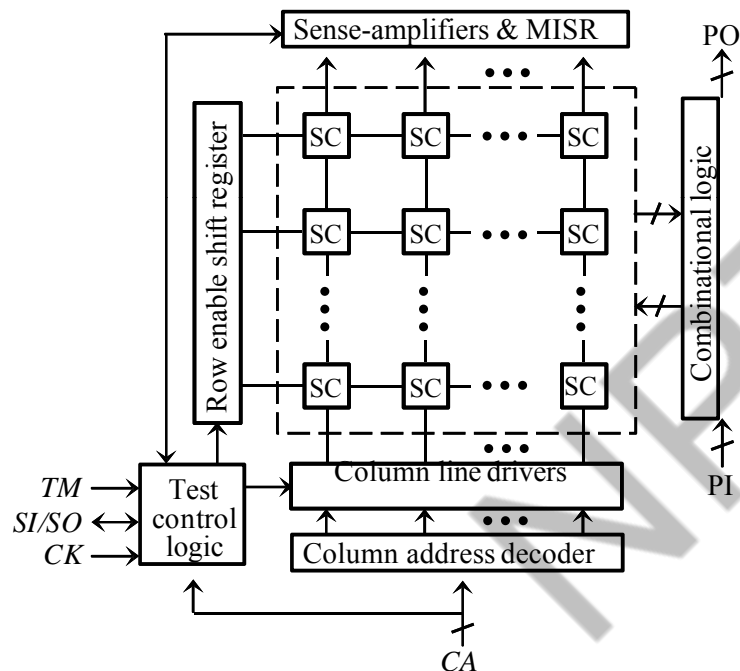
PRAS scan cell design

Structure is similar to that of a *static random access memory* (SRAM) cell or a grid addressable latch.

In **normal** mode, all horizontal row enable (RE) signals are set to 0, forcing each scan cell to act as a normal D flip-flop.

In **test** mode, to capture the test response from D , the RE signal is set to 0 and a pulse is applied on clock Φ , which causes the value on D to be loaded into the scan cell.

Progressive Random-Access Scan (PRAS)



Rows are enabled in a fixed order.

It is only necessary to supply a column address to specify which scan cell in an enabled row to access.

PRAS Architecture

DFT (Contd.)

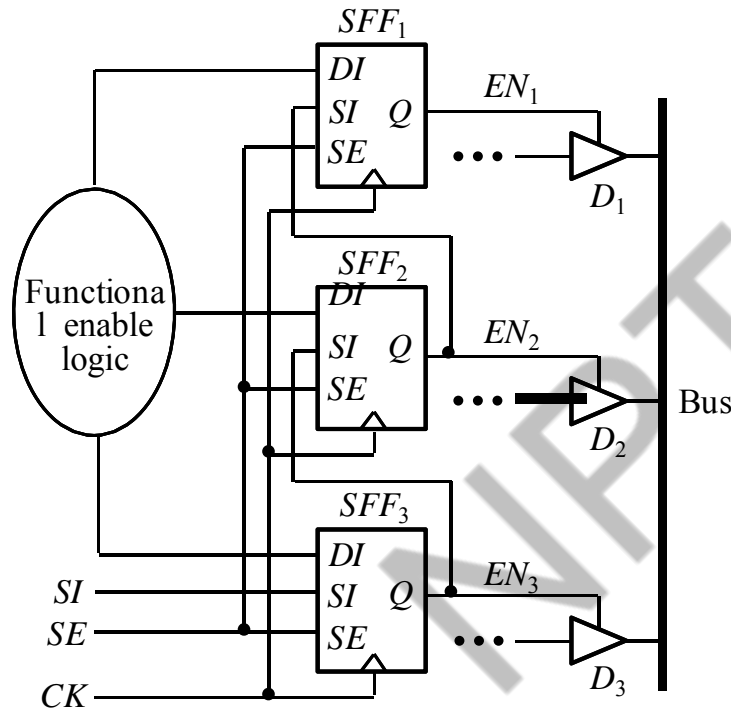
Lecture 9

NPTEL

Scan Design Rules

<i>Design Style</i>	<i>Scan Design Rule</i>	<i>Recommended Solution</i>
Tri-state buses	Avoid during shift	Fix bus contention during shift
Bi-directional I/O ports	Avoid during shift	Force to input or output mode during shift
Gated clocks (muxed-D full-scan)	Avoid during shift	Enable clocks during shift
Derived clocks (muxed-D full-scan)	Avoid	Bypass clocks
Combinational feedback loops	Avoid	Break the loops
Asynchronous set/reset signals	Avoid	Use external pin(s)
Clocks driving data	Avoid	Block clocks to the data portion
Floating buses	Avoid	Add bus keepers
Floating inputs	Not recommended	Tie to Vcc or ground
Cross-coupled NAND/NOR gates	Not recommended	Use standard cells
Non-scan storage elements	Not recommended for full-scan Design	Initialize to known states, bypass, or make transparent

Tri-State Buses



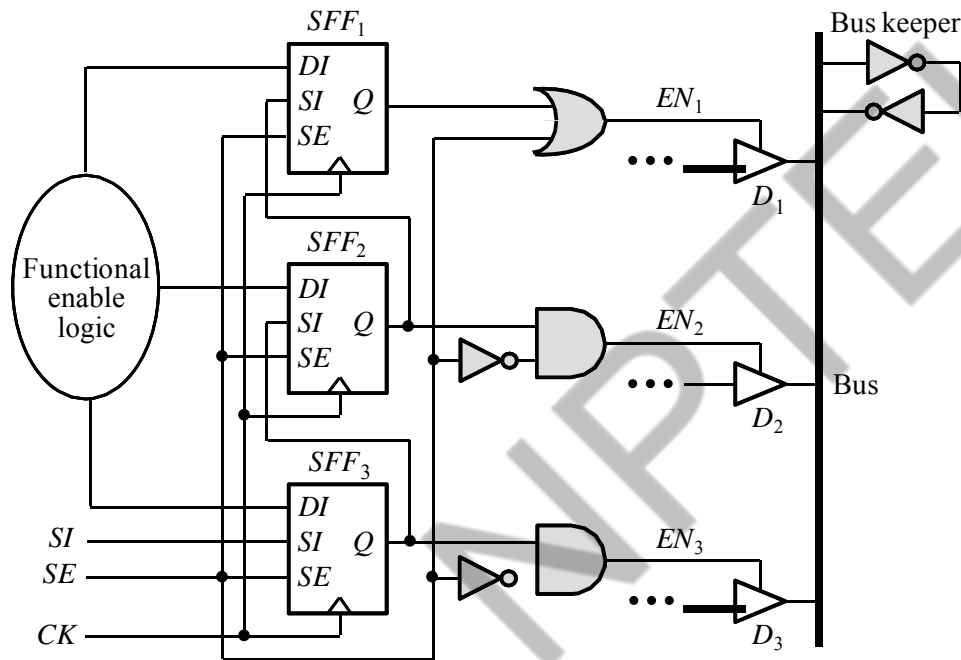
Original Circuit

Bus contention occurs when two bus drivers force opposite logic values onto a tri-state bus.

Bus contention is designed not to happen during the normal operation, and is typically avoided during the capture operation.

However, during the shift operation, no such guarantees can be made.

Tri-State Buses

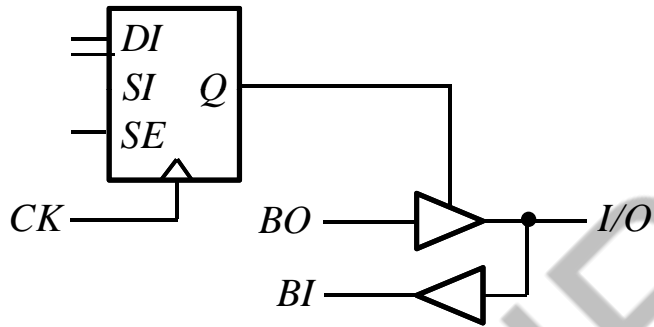


EN_1 is forced to 1 to enable the D_1 bus driver, while EN_2 and EN_3 are set to 0 to disable both D_2 and D_3 bus drivers, when $SE = 1$.

A bus without a pull-up, pull-down, or bus keeper may result in fault coverage loss, the bus keeper is added.

Modified circuit fixing bus contention

Bi-Directional I/O Ports

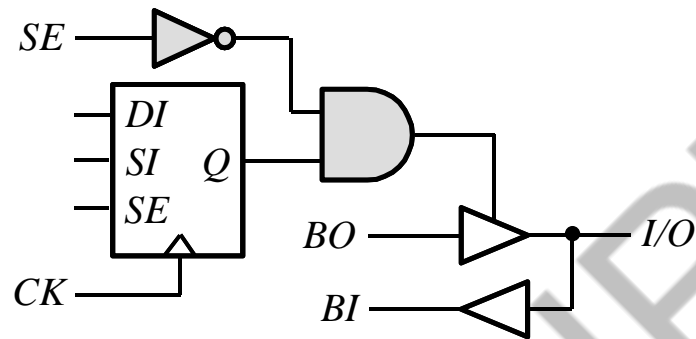


(a) Original circuit

Conflicts may occur at a bidirectional I/O port during the shift operation.

Since the output value of the scan cell can vary during the shift operation, the output tri-state buffer may become active, resulting in a conflict if *BO* and the I/O port driven by the tester have opposite logic values.

Bi-Directional I/O Ports

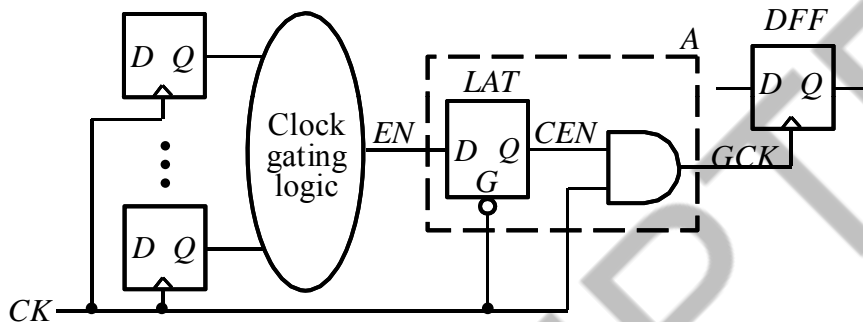


(b) Modified circuit

Fix this problem by forcing the tri-state buffer to be inactive when $SE = 1$, and the tester is used to drive the I/O port during the shift operation.

During the capture operation, the applied test vector determines whether a bi-directional I/O port is used as input or output and controls the tester appropriately.

Gated Clocks

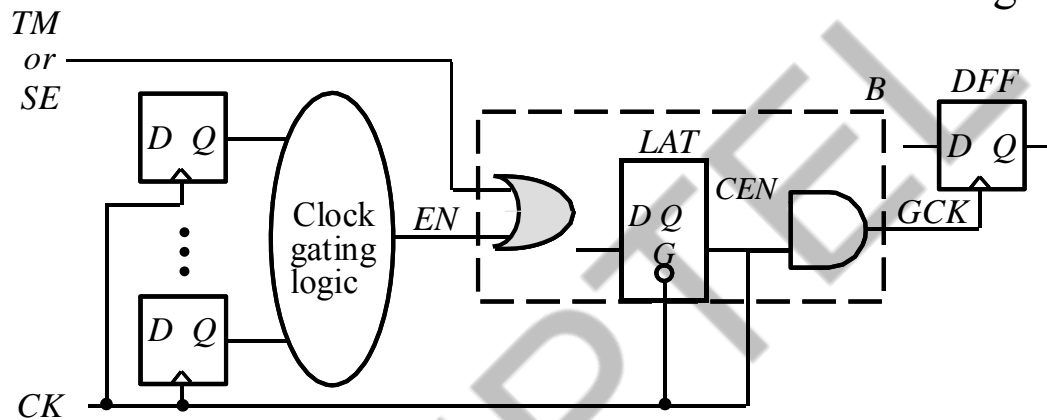


(a) Original circuit

Although clock gating is a good approach for reducing power consumption, it prevents the clock ports of some flip-flops from being directly controlled by primary inputs.

Gated Clocks

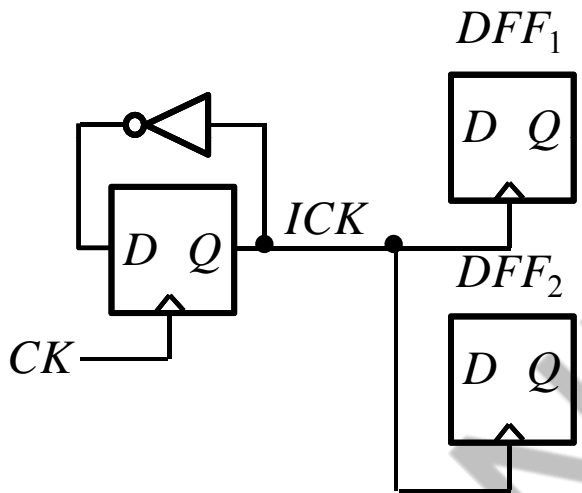
The clock gating function should be disabled at least during the shift operation.



(b) Modified Circuit

An **OR** gate is used to force *CEN* to 1 using either the test mode signal *TM* or the scan enable signal *SE*.

Derived clocks

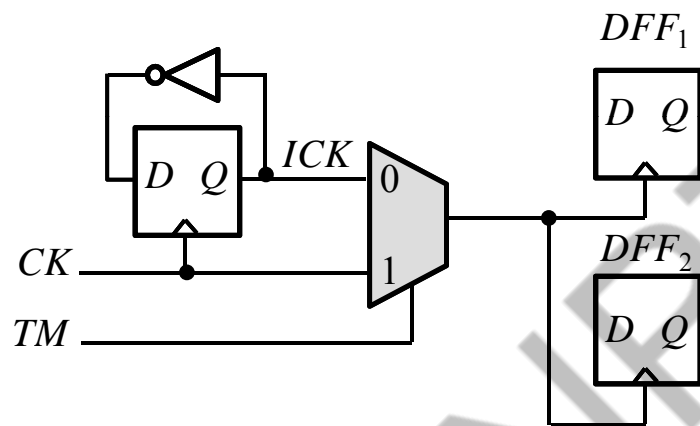


(a) Original circuit

A **derived clock** is a clock signal generated internally from a storage element or a clock generator.

These clock signals need to be bypassed during the entire test operation.

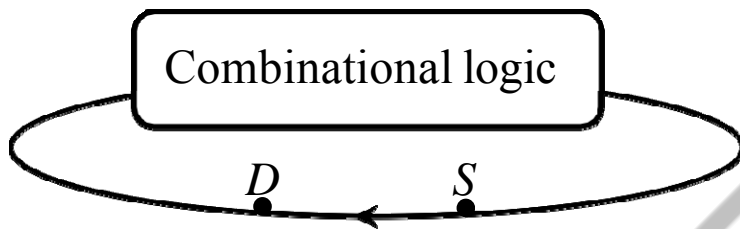
Derived clocks



A multiplexer selects CK , which is a clock directly controllable from a primary input, to drive DFF_1 and DFF_2 during the entire test operation, when $TM = 1$.

(b) Modified circuit

Combinational Feedback Loops

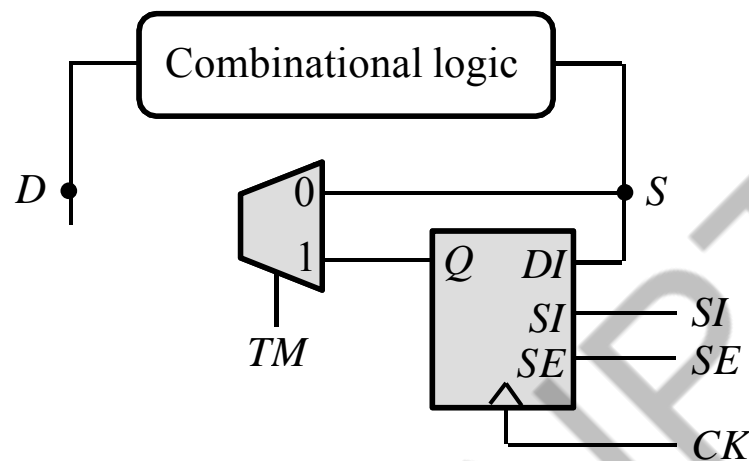


(a) Original circuit

The best way is to
rewrite the RTL
code.

- Depending on whether the number of inversions on a combinational feedback loop is even or odd, it can
- introduce either sequential behavior or oscillation into a design.
- Since the value stored in

Combinational Feedback Loops

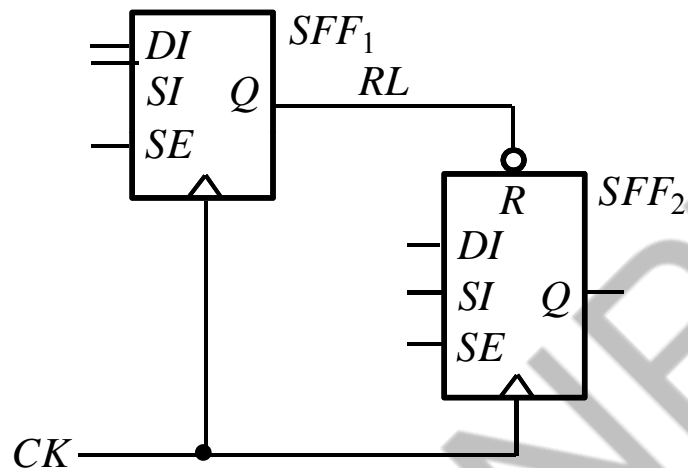


It can be fixed by using a test mode signal TM .

This signal permanently disables the loop throughout the entire shift and capture operations, by inserting a scan point to break the loop.

(b) Modified circuit

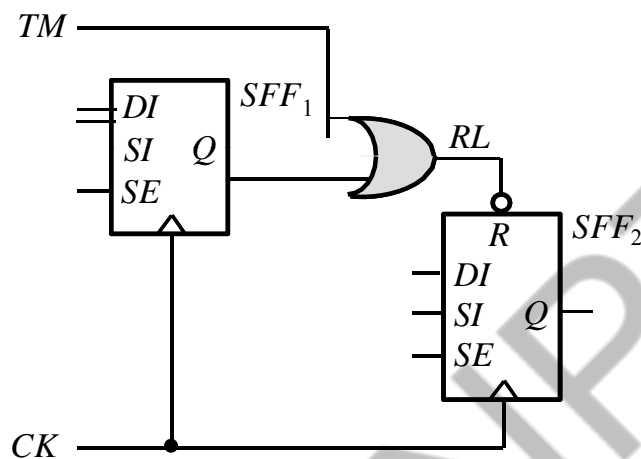
Asynchronous Set/Reset Signals



Asynchronous set/reset signals of scan cells that are not directly controlled from primary inputs can prevent scan chains from shifting data properly.

(a) Original circuit

Asynchronous Set/Reset Signals

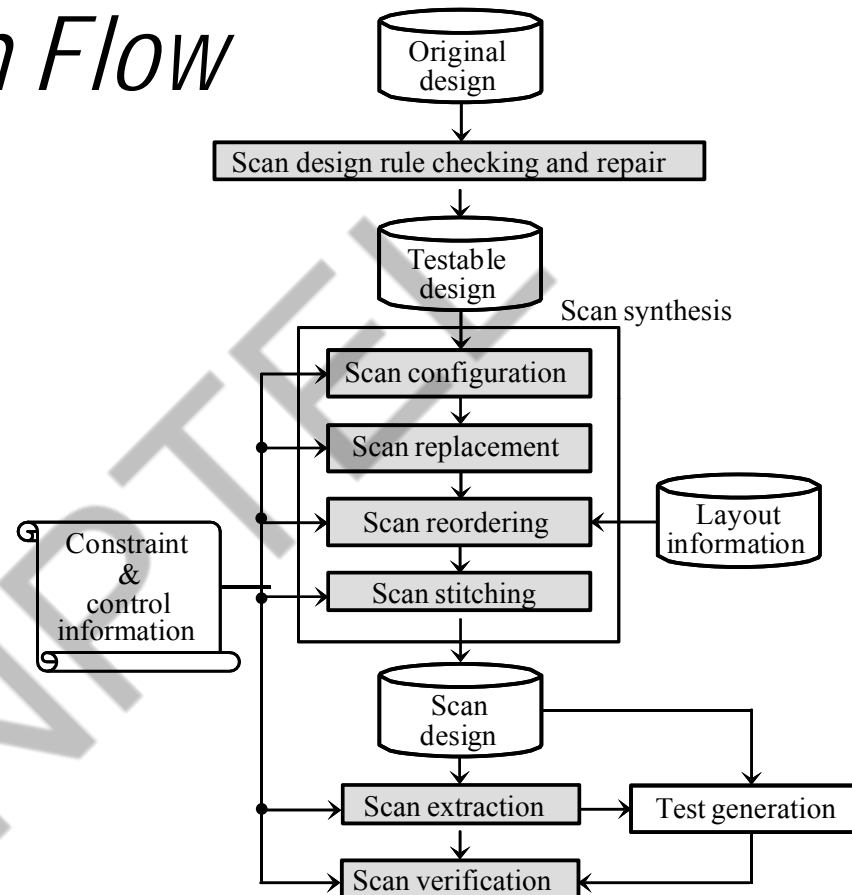


(b) Modified circuit

To avoid this problem, these asynchronous set/reset signals are forced to an inactive state during the shift operation.

Use an **OR** gate with an input tied to the test mode signal TM . When $TM = 1$, the asynchronous reset signal RL of scan cell SFF_2 is permanently disabled during the entire test operation.

Scan Design Flow



Scan Design Flow

D Scan Design Rule Checking and Repair

- Identify and repair all scan design rule violations to convert the original design into a testable design
- Also performed after scan synthesis to confirm that no new violations exist

D Scan Synthesis

- Converts a testable design into a scan design without affecting the functionality of the original design
 - Scan Configuration
 - Scan Replacement
 - Scan Reordering
 - Scan Stitching

Scan Design Flow

D Scan Extraction

- Is the process used for extracting all scan cell instances from all scan chains specified in the scan design

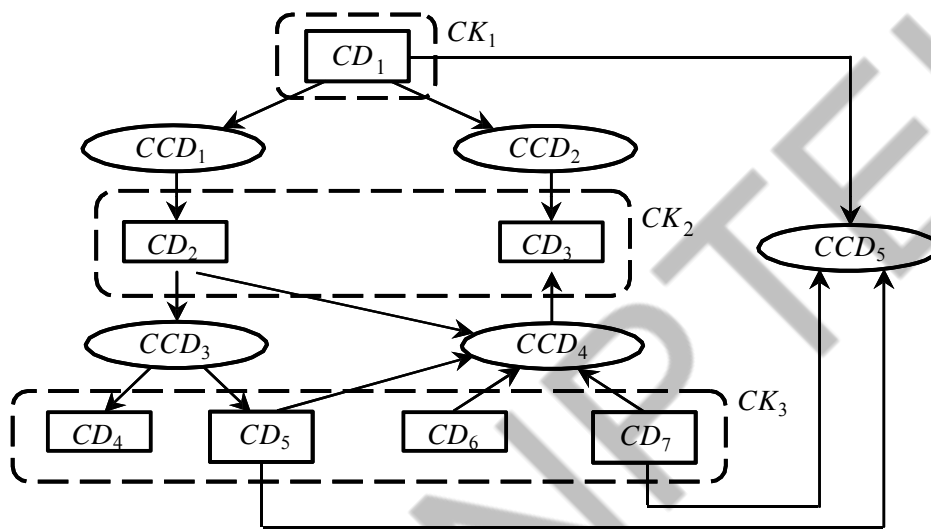
D Scan Verification

- A timing file in *standard delay format* (SDF) which resembles the timing behavior of the manufactured device is used to
 - Verifying the scan shift operation
 - Verifying the scan capture operation

D Scan Design Costs

- Area overhead cost:
- I/O pin cost
- Performance degradation cost
- Design effort cost

Scan Design Rule Checking and Repair



An arrow means a data transfers from one clock domain to a different clock domain.

7 clock domains, $CD_1 \sim CD_7$

5 crossing-clock-domain data paths, $CCD_1 \sim CCD_5$

Clock grouping example

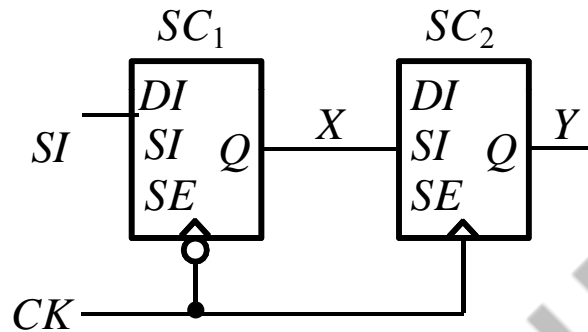
Scan Synthesis

- Includes four separate and distinct steps:
 - Scan Configuration
 - The number of scan chains used
 - The types of scan cells used to implement these scan chains
 - Which storage elements to exclude from the process
 - How the scan cells are arranged
 - Scan Replacement
 - Replaces all original storage elements in the testable design with their functionally-equivalent scan cells
 - Scan Reordering
 - The process of reordering the scan chains based on the physical scan cell locations, in order to minimize the amount of interconnect wires used to implement the scan chains
 - Scan Stitching
 - Stitch all scan cells together to form scan chains

DFT (Contd.)
Lecture 10

Scan Synthesis - Scan Configuration

Mixing negative-edge and positive-edge scan cells in a scan chain

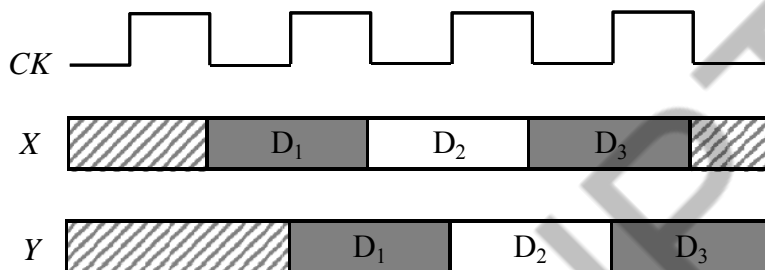


This circuit structure comprising a negative-edge scan cell followed by a positive-edge scan cell.

Circuit Structure

Scan Synthesis - Scan Configuration

Mixing negative-edge and positive-edge scan cells in a scan chain

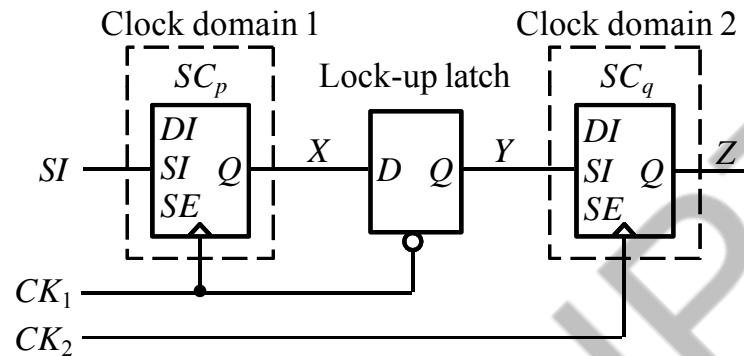


Timing Diagram

Y will first take on the state *X* at the rising *CK* edge, before *X* is loaded with the *SI* value at the falling *CK* edge.

If we accidentally place the positive-edge scan cell before the negative-edge scan cell, both scan cells will always incorrectly contain the same value at the end of each shift clock cycle.

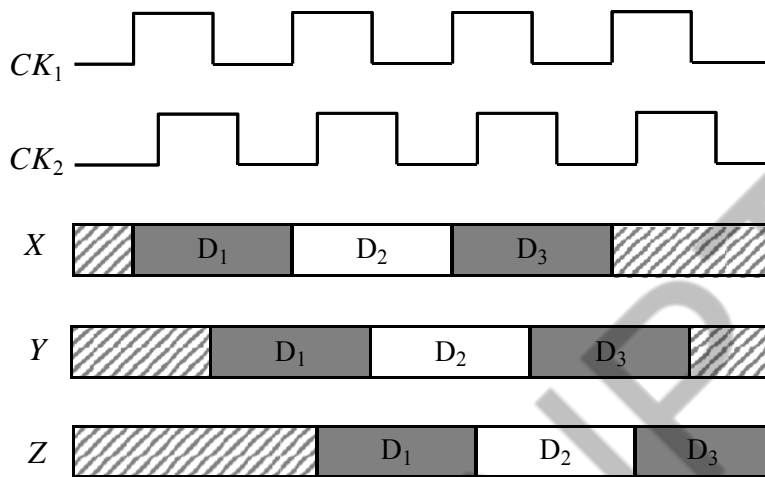
Scan Synthesis - Scan Configuration



Circuit Structure

A lock-up latch is inserted between adjacent cross-clock-domain scan cells, in order to guarantee that any clock skew between the clocks can be tolerated.

Scan Synthesis - Scan Configuration



During each shift clock cycle, *X* will first take on the *SI* value at the rising *CK*₁ edge. Then, *Z* will take on the *Y* value at the rising *CK*₂ edge.

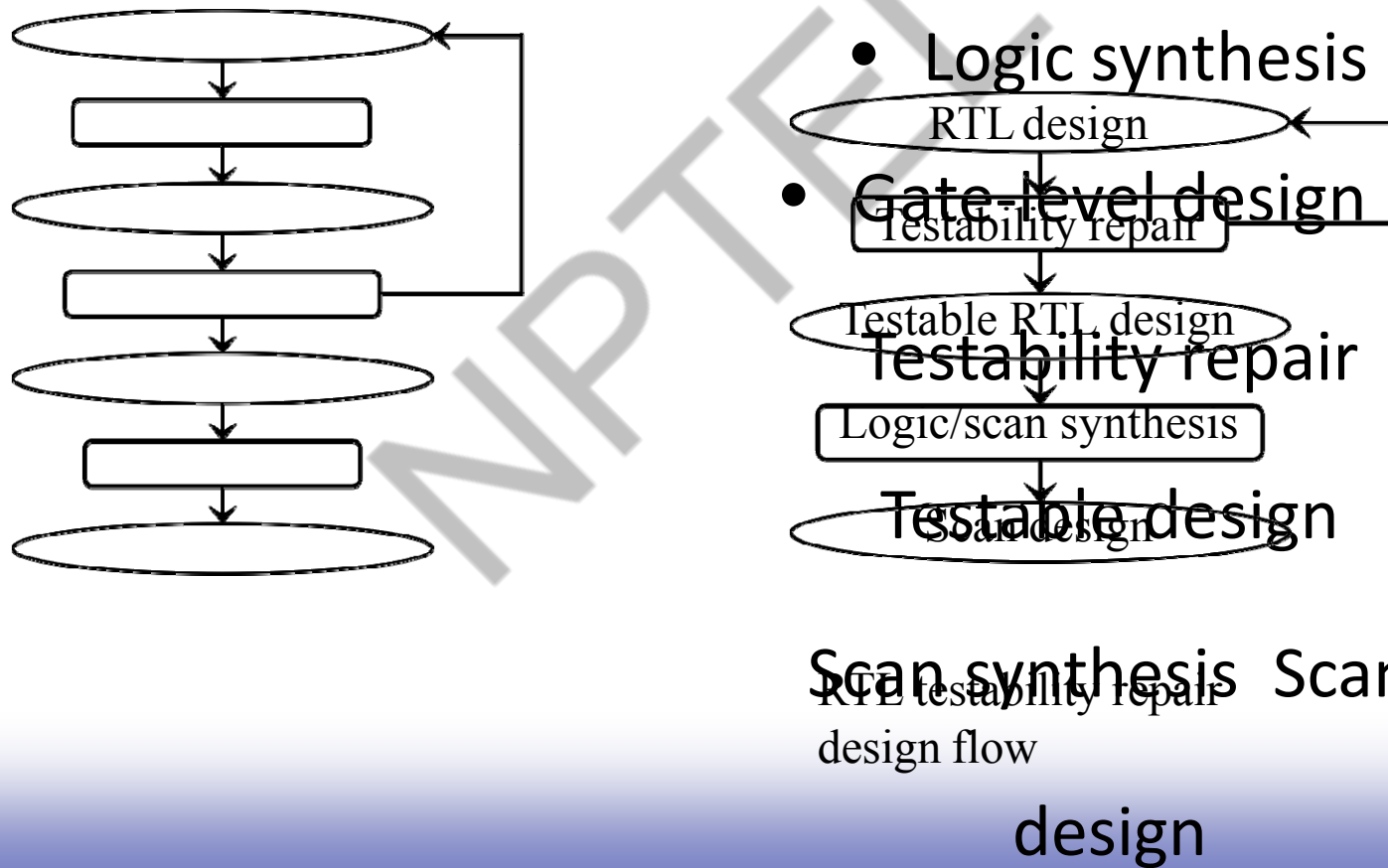
Timing diagram

RTL Design for Testability

□ Why are RTL designs needed?

- Growth of device number
- Tight timing
- Potential yield loss
- Low-power issues
- Increased core reusability
- Time-to market pressure

Comparison of design flows at RTL and Gate-level



RTL Scan Design Rule Checking

▯ Fast synthesis

- Mapped onto combinational primitives and high-level models

▯ Identify testability problems

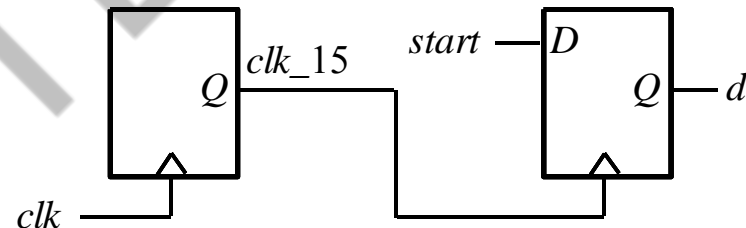
- Static solutions (without simulation)
- Dynamic solutions (with simulation)

RTL Scan Design Repair – An Example

D original

```
always @(posedge clk)
  if (q == 4'b1111)
    clk_15 <= 1;
  else
    begin
      clk_15 <= 0;
      q <= q + 1;
    end
always @(posedge clk_15)
  d <= start;
```

(a) Generated clock (RTL code)

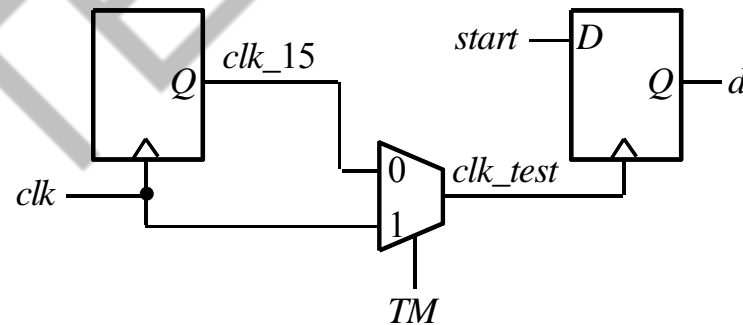


(b) Generated clock (Schematic)

RTL Scan Design Repair – An Example

Automatic repair at the RTL using *TM*

```
always @(posedge clk)
  if (q == 4'b1111)
    clk_15 <= 1;
  else
    begin
      clk_15 <= 0;
      q <= q + 1;
    end
assign clk_test = (TM)? clk : clk_15;
always @(posedge clk_test)
  d <= start;
```



(c) Generated clock (RTL code)

(d) Generated clock repair (Schematic)

RTL Scan Synthesis

▷ RTL scan synthesis

- The scan equivalent of each storage element refers to an RTL structure
- The scan chains are inserted into the RTL design

▷ Pseudo RTL scan synthesis

- Specify pseudo primary inputs and pseudo primary outputs
- Can cope with many other DFT structures
- Perform one-pass or single-pass synthesis

RTL Scan Extraction and Verification

D Scan extraction

- Rely on performing fast synthesis on the RTL scan design
- Generate a software model for tracing the scan connection

D Scan verification

- Rely on generating a flush testbench to simulate flush tests
- The flush testbench can be used for both RTL and gate-level designs
- Apply broadside-load test for verifying the scan capture operation at RTL

Concluding Remarks

- ▯ DFT has become vital for ensuring product quality
- ▯ Scan design is the most widely used DFT technique
- ▯ New design and test challenges
 - Further reduce test power, test data volume and test application time
 - Cope with physical failures of the nanometer design era